Product data sheet

1. General description

NPN/PNP double Resistor-Equipped Transistors (RET) in a leadless ultra small DFN1010B-6 (SOT1216) Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- · Simplifies circuit design
- Low package height of 0.37 mm
- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

3. Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications
- Mobile applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor; for the PNP transistor with negative polarity							
V _{CEO}	collector-emitter voltage	open base		-	-	50	V
I _O	output current			-	-	100	mA
Per transistor; for the PNP transistor with negative polarity							
R1	resistance 1	T _{amb} = 25 °C		33	47	61	kΩ
R2/R1	resistance ratio			0.8	1	1.2	





NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	GND1	GND (emitter) TR1	500	O1 I2 GND2	
2	I1	input (base) TR1	$\begin{bmatrix} 1 \\ 7 \end{bmatrix} \begin{bmatrix} 6 \\ \end{bmatrix}$		
3	O2	output (collector) TR2	2 5	R1 R2	
4	GND2	GND (emitter) TR2	3 8 4		TR1 TR2
5	12	input (base) TR2			R2 R1
6	O1	output (collector) TR1	Transparent top view		
7	O1	output (collector) TR1	DFN1010B-6 (SOT1216)	GND1 I1 O2 aaa-007379	
8	O2	output (collector) TR2		dad 557575	

6. Ordering information

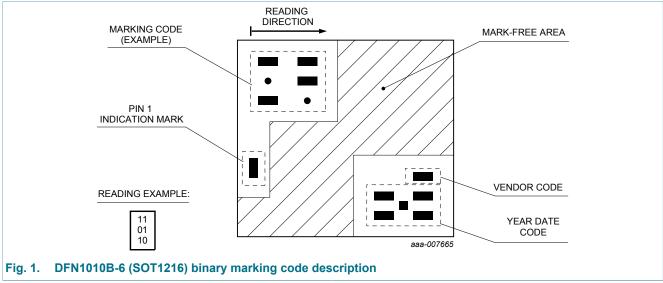
Table 3. Ordering information

Type number	Package	ackage					
	Name	Description	Version				
PQMD12	DFN1010B-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals	SOT1216				

7. Marking

Table 4. Marking codes

Type number	Marking code
PQMD12	11 00 00



PQMD12

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NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

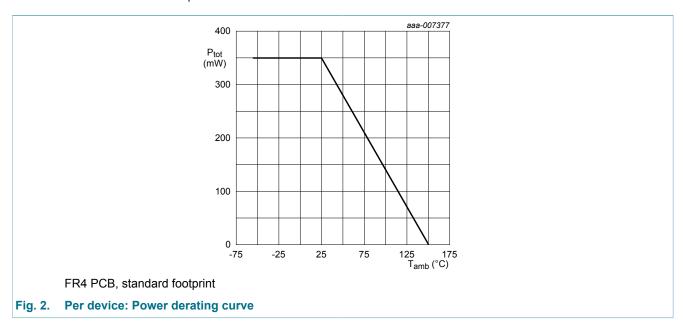
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transis	tor; for the PNP transistor with	negative polarity				
V _{CBO}	collector-base voltage	open emitter		-	50	V
V _{CEO}	collector-emitter voltage	open base		-	50	V
V _{EBO}	emitter-base voltage	open collector		-	10	V
VI	input voltage	TR1; positive		-	40	V
		TR1; negative		-	-10	V
		TR2; positive		-	10	V
		TR2; negative		-	-40	V
I _O	output current			-	100	mA
I _{CM}	peak collector current	t _p ≤ 1 ms; single pulse;		-	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	230	mW
Per device						
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	350	mW
T _j	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



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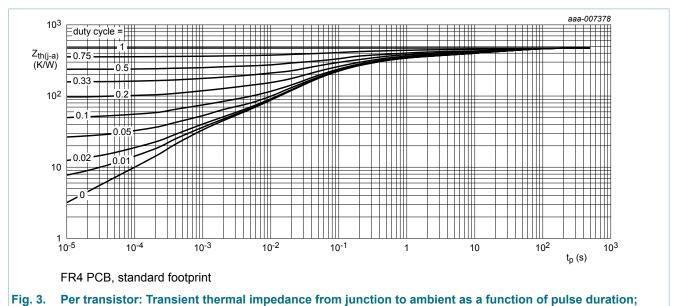
NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor	Per transistor						
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	543	K/W
Per device							
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	357	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



typical values

10. Characteristics

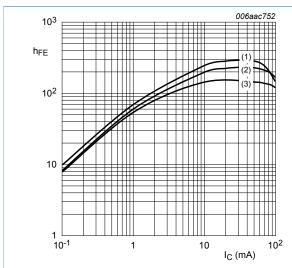
Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor; for the PNP transistor with negative polarity							
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0 A; T _{amb} = 25 °C		-	-	100	nA
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0 A; T _{amb} = 25 °C		-	-	1	μA
		V _{CE} = 30 V; I _B = 0 A; T _{amb} = 150 °C		-	-	5	μA
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0 A; T _{amb} = 25 °C		-	-	90	μA
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NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
h _{FE}	DC current gain	V_{CE} = 5 V; I_{C} = 5 mA; T_{amb} = 25 °C		80	-	-	
V _{CEsat}	collector-emitter saturation voltage	I_C = 10 mA; I_B = 0.5 mA; T_{amb} = 25 °C		-	-	150	mV
$V_{I(off)}$	off-state input voltage	V _{CE} = 5 V; I _C = 100 μA; T _{amb} = 25 °C		-	1.2	0.8	V
$V_{I(on)}$	on-state input voltage	$V_{CE} = 0.3 \text{ V}; I_{C} = 2 \text{ mA}; T_{amb} = 25 ^{\circ}\text{C}$		3	1.6	-	V
R1	resistance 1	T _{amb} = 25 °C		33	47	61	kΩ
R2/R1	resistance ratio			0.8	1	1.2	
C _c cc	collector capacitance	V _{CB} = 10 V; I _E = 0 A; f = 1 MHz; T _{amb} = 25 °C; TR1 (NPN)		-	-	2.5	pF
		V _{CB} = -10 V; I _E = 0 A; f = 1 MHz; T _{amb} = 25 °C; TR2 (PNP)		-	-	3	pF
f _T	transition frequency	V _{CE} = 5 V; I _C = 10 mA; f = 100 MHz; T _{amb} = 25 °C; TR1 (NPN)	[1]	-	230	-	MHz
		V_{CE} = -5 V; I_{C} = -10 mA; f = 100 MHz; T_{amb} = 25 °C; TR2 (PNP)	[1]	-	180	-	MHz

[1] Characteristics of built-in transistor



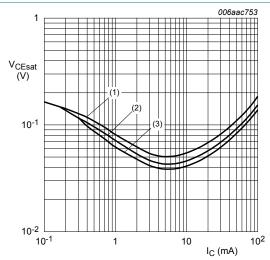
 $V_{CE} = 5 V$

(1) T_{amb} = 100 °C

(2) T_{amb} = 25 °C

(3) $T_{amb} = -40 \, ^{\circ}C$

Fig. 4. NPN transistor: DC current gain as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 20$

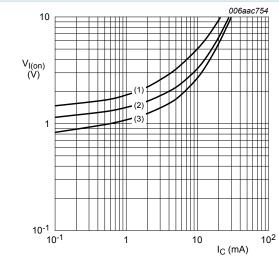
(1) T_{amb} = 100 °C

(2) T_{amb} = 25 °C

(3) $T_{amb} = -40 \, ^{\circ}C$

NPN transistor: Collector-emitter saturation voltage as a function of collector current; typical values

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω



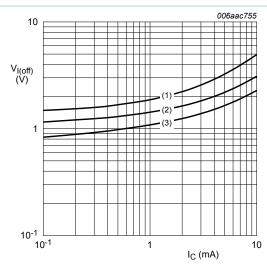
$$V_{CE} = 0.3 V$$

(1)
$$T_{amb} = -40 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb}$$
 = 100 °C

Fig. 6. NPN transistor: On-state input voltage as a function of collector current; typical values



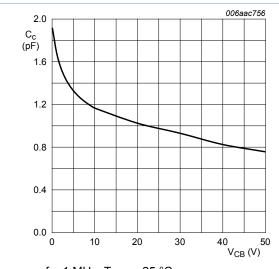
$$V_{CE} = 5 V$$

(1)
$$T_{amb} = -40 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

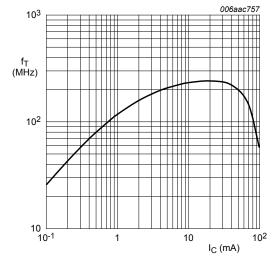
(3)
$$T_{amb}$$
 = 100 °C

Fig. 7. NPN transistor: Off-state input voltage as a function of collector current; typical values



 $f = 1 MHz; T_{amb} = 25 °C$

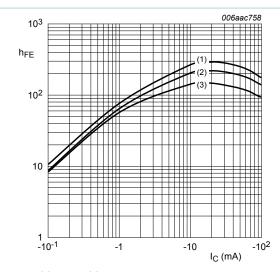
Fig. 8. NPN transistor: Collector capacitance as a function of collector-base voltage; typical values



 V_{CE} = 5 V; T_{amb} = 25 °C

Fig. 9. NPN transistor: Transition frequency as a function of collector current; typical values of built-in transistor

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω



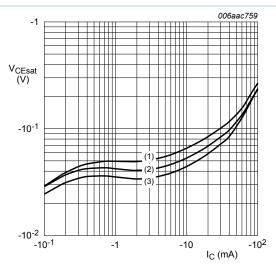
$$V_{CE}$$
 = -5 V

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -40 \, ^{\circ}C$$





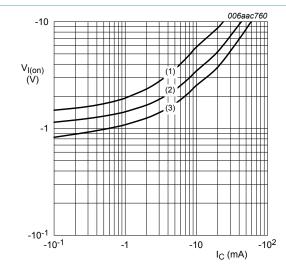
$$I_{\rm C}/I_{\rm B} = 20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -40 \, ^{\circ}C$$





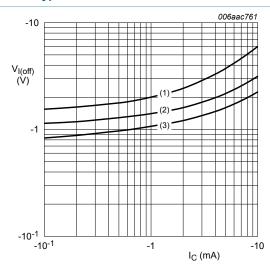
$$V_{CE}$$
 = -0.3 V

(1)
$$T_{amb} = -40 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig. 12. PNP transistor: On-state input voltage as a function of collector current; typical values



$$V_{CE} = -5 V$$

(1)
$$T_{amb} = -40 \, ^{\circ}C$$

(2)
$$T_{amb}$$
 = 25 °C

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig. 13. PNP transistor: Off-state input voltage as a function of collector current; typical values

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

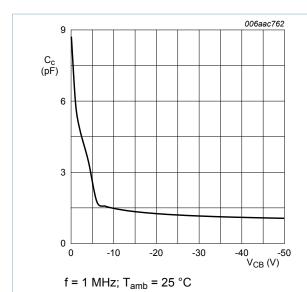


Fig. 14. PNP transistor: Collector capacitance as a function of collector-base voltage; typical values of built-in transistor

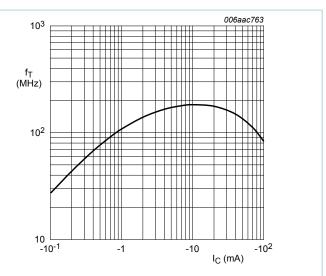


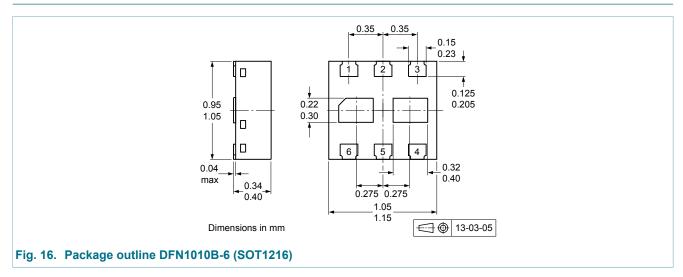
Fig. 15. PNP transistor: Transition frequency as a function of collector current; typical values of built-in transistor

11. Test information

11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

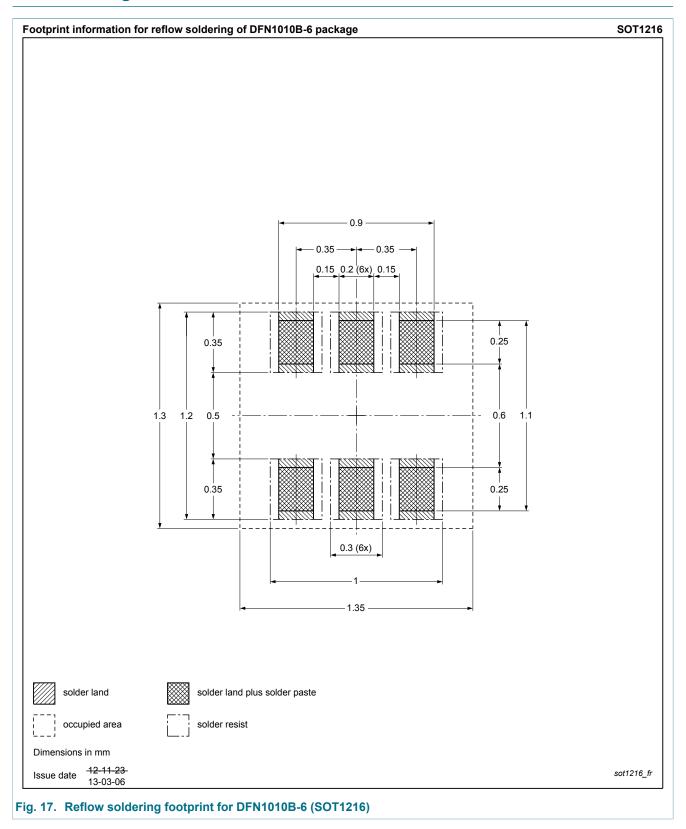
12. Package outline



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NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

13. Soldering



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NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PQMD12 v.1	20130724	Product data sheet	-	-

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = 47 k Ω

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